■ MN102H730F , MN102H73G , MN102H73K

Туре	MN102H730F	MN102H73G (under development)	MN102H73K (under development)		
ROM (×8-bit)	External	128 K	256 K		
RAM (×8-bit)	10 K	10 K	12 K		
Package	TQFP128-P-1414B *Lead-free	TQFP128-	8-P-1414A *Lead-free		
Minimum Instruction Execution Time	With main clock operated 58 ns (at 3.0 V to 3.6 V, 34 MHz)				
Interrupts	• RST pin • Watchdog • NMI pin • Timer counter 0 to 9 underflow • Timer counter 10 to 14 underflow • Timer counter 10 to 14 compare capture A • Timer counter 10 to 14 compare capture B • ATC ch.0 to 1 transfer finish • ETC ch.0 to 1 transfer finish • External 0 to 7 • Serial ch.0 to 4 transmission • Serial ch.0 to 4 reception • A/D conversion finish				
Timer Counter	S	1/2 of system clock (BOSC) frequency; u system clock (BOSC) underflow of timer counter 0	nderflow of timer counter 8; TM0IO p		
	t	1/2 of system clock (BOSC) frequency; u imer counter 0 output underflow of timer counter 1	nderflow of timer counter 8; TM1IO p		
	t	1/2 of system clock (BOSC) frequency; u imer counter 1 output inderflow of timer counter 2	nderflow of timer counter 8; TM2IO p		
	t	1/2 of system clock (BOSC) frequency; u imer counter 2 output underflow of timer counter 3	nderflow of timer counter 8; TM3IO		
	Timer counter 4 : 8-bit × 1 Clock source	1/2 of system clock (BOSC) frequency; u system clock (BOSC) underflow of timer counter 4	nderflow of timer counter 9; TM4IO		
	Timer counter 5 : 8-bit × 1 Clock source	1/2 of system clock (BOSC) frequency; u imer counter 4 output anderflow of timer counter 5	nderflow of timer counter 9; TM5IO		
	Timer counter 6 : 8-bit × 1 Clock source	1/2 of system clock (BOSC) frequency; u imer counter 5 output underflow of timer counter 6	nderflow of timer counter 9; TM6IO		
	Timer counter 7 : 8-bit × 1 Clock source	1/2 of system clock (BOSC) frequency; u imer counter 6 output underflow of timer counter 7	nderflow of timer counter 9; TM7IO		
	Timer counter 8 : 8-bit × 1 Clock source	1/2 of system clock (BOSC) frequency; syl/4 of system clock (XI) frequency; TM8.			

MN102H730F , MN102H73G , MN102H73K \square

Timer Counter	(Continue)	Timer counter 9: 8-bit × 1				
, ,		Clock source 1/2 of system clock (BOSC) frequency; 1/64 of system clock (BOSC) frequency; TM9IO pin; timer counter 8 output				
		Interrupt source underflow of timer counter 9				
		Timer counter 10: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock source				
		Interrupt source				
		Timer counter 11: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock source				
		Timer counter 12: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock source				
		Timer counter 13: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock source				
		Timer counter 14: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock source				
Serial Interface		Serial 0, 1 : 8-bit × 1 (transfer direction of MSB / LSB selectable, transmission / reception of 7, 8-bit length) Clock source				
		Serial 2, 3: 8-bit × 1 (transfer direction of MSB / LSB selectable, transmission / reception of 7, 8-bit length) Clock source				
		UART × 4 (common use with serial 0 to 3)				
		$I^2C \times 2$ (common use with serial 1,3; single master)				
Multiply-and-Ac	cumulate	16 -bit sign \times 16 -bit sign $+$ 40 -bit sign				
I/O Pins	I/O	Common use: 59 (use of full address, address data separate 16-bit mode) Common use: 76 (use of address 16-bit, address data separate 8-bit mode)				
A/D Inputs		10 -bit \times 12-ch. (with S/H)				
D/A Outputs		8-bit \times 4-ch.				
PWM		16-bit × 5-ch. (timer counter 10 to 14)				
ICR		16-bit × 5-ch. (timer counter 10 to 14)				
OCR		16-bit × 5-ch. (timer counter 10 to 14)				
Notes		Address / data separate bus interface; 8 / 16-bit bus width selectable; SRAM interface				

See the next page for electrical characteristics, pin assignment and support tool.

MAE00010EEM Panasonic 2

Electrical Characteristics

Supply current

Parameter	Symbol	Condition		Limit		
	Symbol			typ	max	Unit
Operating supply current	IDDom	VI = VDD or VSS, output open	60+10α*		A	
	IDDopr	f = 34 MHz , VDD = 3.3 V			00+10a*	* mA
Supply current at STOP	IDDS	Pin with pull-up resistor is open all other input pins and Hi-Z state input/output			70	μА
	משמו					
Supply current at HALT	IDDH	pins are simultaneously applied VDD or VSS level			30+10α*	mA
	חטטו	f = 34 MHz, VDD = 3.3 V, output open		30+100**		

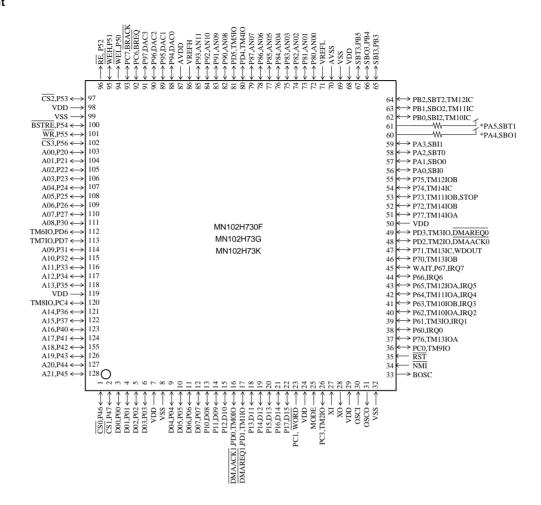
(Ta = -40° C to $+85^{\circ}$ C , VDD = AVDD = 3.3 V , VSS = AVSS = 0 V) * " α " depends on products .

 $MN102H73G/73K/730F\ \alpha=0$

MN102HF73G $\alpha = 1$

MN102HF73K $\alpha = 2$

Pin Assignment



Support Tool

In-circuit Emulator	PX-ICE102H73-128P1414	
Flash Memory Built-in Type	Туре	MN102HF73G, MN102HF73K
	ROM (× 8-bit)	128 K / 256 K
	RAM (× 8-bit)	10 K / 12 K
	Minimum instruction execution time	58 ns (at 3.0 V to 3.6 V, 34 MHz)
	Package	TQFP128-P-1414B *Lead-free

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